



SDM2U40CSP

2A SCHOTTKY BARRIER RECTIFIER CHIP SCALE PACKAGE

Product Summary

V _{RRM} (V)	I _O (A)	V _{F max} (V)	I _{R max} (μΑ)
40	2.0	0.53	150

Features and Benefits

- Low forward voltage (V_F) minimizes conduction losses and improves efficiency.
- Reduced high temperature reverse leakage; Increased reliability against thermal runaway failure in high temperature operation.
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

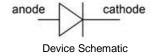
Description and Applications

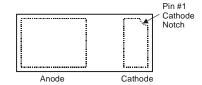
The SDM2U40CSP is a 40-volt 2A Schottky Barrier Rectifier that is optimized for low forward voltage drop and low leakage current, housed in a compact chip scale package (CSP) that occupies only 1.28mm² board space with low profile. The low thermal resistance enables designers to meet design challenges of increasing efficiency whilst at the same time reducing board space. It is ideally suited for use in portable applications as a:

- Blocking Diode
- Boost Diode
- Switching Diode
- Reverse Protection Diode

Mechanical Data

- Case: X3-WLB1608-2
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiAu Bump. Solderable per MIL-STD-202, Method 208 (e4)
- Polarity: Cathode Dot
- Weight: 0.001 grams (Approximate)





Ordering Information (Note 4)

Part Number	Case	Packaging
SDM2U40CSP-7B	X3-WLB1608-2	10,000/Tape & Reel

Notes:

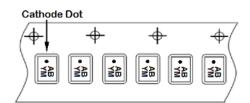
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Pin 1



X6= Product Type Marking Code YM=Date Code Marking Y or Y= Year (ex: C= 2015) M=Month (ex: 9= September) Dot Denotes Cathode Pin



Date Code Key

Year	201	4	2015		2016	20	17	2018		2019	2	2020
Code	В		С		D			F		G		Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	40	V
Average Rectified Output Current	lo	2.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	28	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{ heta JA}$	200	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	65	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

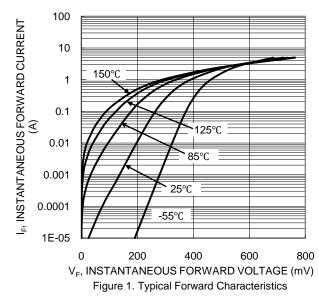
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

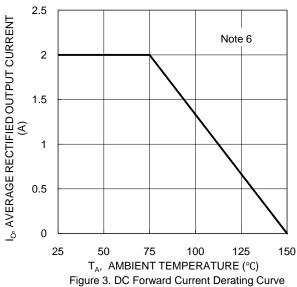
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Famuurd Valtage Dran	V _F	_	0.39	0.44	V	I _F = 1.0A, T _J = +25°C
Forward Voltage Drop		_	0.48	0.53		I _F = 2.0A, T _J = +25°C
Reverse Current (Note 7)	I _R	_	_	150	μA	V _R = 40V, T _J = +25°C
Junction Capacitance	C _T		85	_	pF	V _R = 5V, f = 1.0MHz

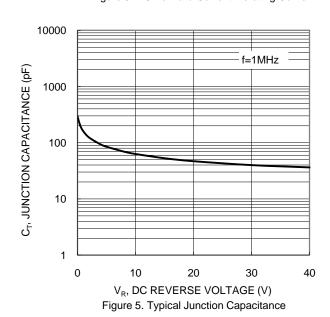
Notes:

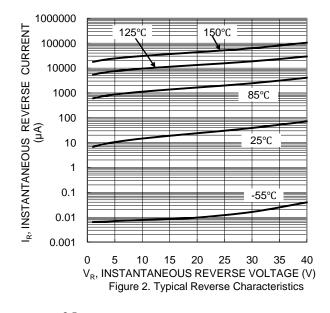
- 5. Device mounted on FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
- 6. Device mounted on 1inch sq. copper pad, 2oz.
- 7. Short duration pulse test used to minimize self-heating effect.

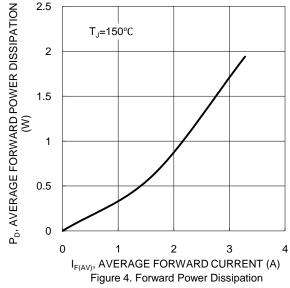










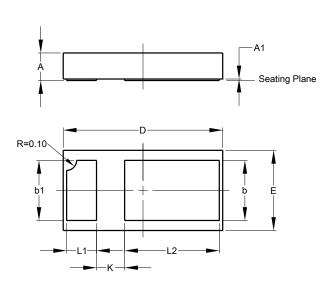




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-WLB1608-2

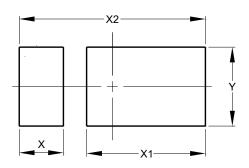


	X3-WLB1608-2							
Dim	Min	Max	Тур					
Α	0.250	0.300	0.275					
A 1	-	0.015	-					
b	-	-	0.600					
b1	-	-	0.600					
D	1.57	1.63	1.60					
E	0.77	0.83	0.80					
K	-	-	0.282					
L1	0.25	0.35	0.30					
L2	0.90	1.00	0.95					
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-WLB1608-2



Dimensions	Value		
Dimensions	(in mm)		
Х	0.385		
X1	1.035		
X2	1.622		
Υ	0.690		



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